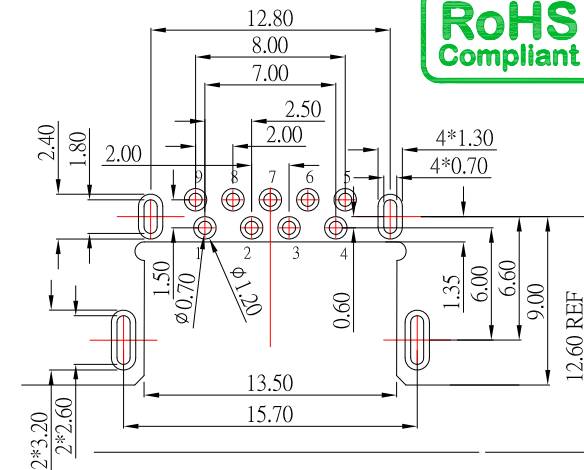


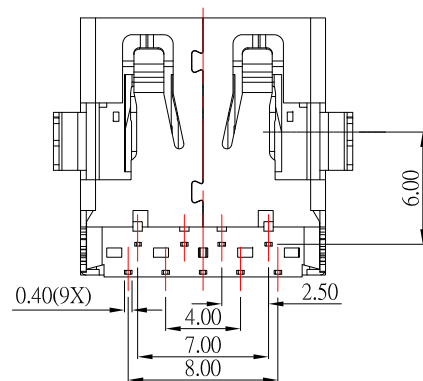
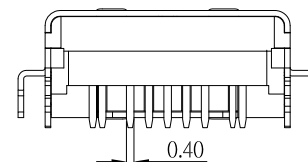
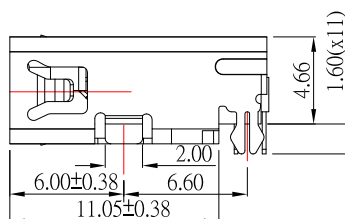
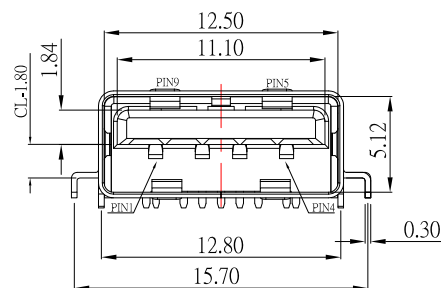
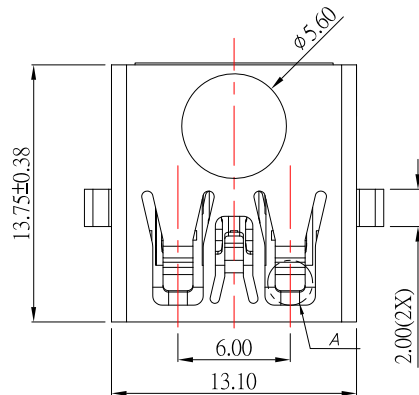


NOTE:

- 1.MATERIAL:
 - 1.1 Housing: LCP
 - 1.2 Contact: Phosphor Bronze
 - 1.3 Shell: SUS201
- 2.Finish:
 - 2.1 Contact: Plated Gold in Mating Area ;
Tin Plated on Solder Balls ;
Nickel under plated overall
 - 2.2 Shell: Nickel under Plated surface layer
- 3.SPECIFICATION:
 - 3.1 Rate: 30V DC , 1.5 A
 - 3.2 Insulator Resistance:100M Ω Min
 - 3.3 Dielectric Strength: 500V AC
 - 3.4 Contact Resistance: 30m Ω Max
 - 3.5 Operation Temperature: -55°C ~ +85°C

—鍍層厚度：

Blank : 1u"
2 : 15u"
3 : 30u"

[illegible]